

## **LOT #154**

Efficient Battery Cooling Systems for Thermal Management of Electric Vehicles



## Lot 154 Portfolio Origin & Toolkit Strategy

#### **General Origin**

The patents have their origin in a big German car supplier (Behr) who was acquired by another supplier (MAHLE).

Following the acqusition, the strategy to offer **System components for Li-Ion-batteries especially** cooling technologies for batteries of Electric Vehicles (EV) was no longer pursued, hence parts of the patent portfolio were transferred to some of the original inventors.

#### Toolbox for Lilon battery cooling

The original applicant planned to create a toolbox for the cooling of Li-Ion batteries:

- For different cell types (pouch vs hardcase)
- Battery architectures (automotive vs off-highway)
- Unit quantities (large series vs small series manufacturers and niches)
- Coolant vs refrigerant media

## Ocean Tomo Bid-Ask Market Lot 154 Portfolio Information

# Overview & Main Characteristics

Patent Family 1 (EP2476151B1, US9112208B2, JP5542209B2, CN102576831B): System patent for modules; Granted and valid in DE, US, JP, CN

**Patent Family 2** (EP247461B1, CN10498601B, JP560335B2): core element connection cooling element esp. for pouch cells; Granted and valid in DE, FR, CN, JP

**Patent Family 3** (EP2476160B1, US9083009B2, CN102576916B, JP5604519B2): Core element for battery structure system with cooling; Granted and valid in DE, FR, US, CN, JP

Patent Family 4 (EP2026387B1): Core element arrester cooling pouch cells; Granted and valid in DE, FR

Patent Family 5 (EP2497145B1, JP5810422B2, CN102771004B):
Core element for flexible cooling (coolant or refrigerant) of hardcase but also pouch cells for large series up to small series
Granted and valid in DE, FR, CN, JP

## Lot 154 Technology Innovation

#### Patent Family 1:

(EP2476151B1, US9112208B2, JP5542209B2, CN102576831B) Module interface represents a new approach for modularization. Modularization well suitable for small quantities with high number of variants; applicable for all OEM

#### Patent Family 2:

(EP247461B1, CN10498601B, JP560335B2) Compensation element represents a new approach for tolerance compensation for cooling plates; pouch cell cooling, applicable for all topologies and OEM platforms

#### Patent Family 3:

(EP2476160B1, US9083009B2, CN102576916B, JP5604519B2) Integrated bottom cooling represents a new approach by integration for light and low cost bottom cooling plate (omission of an additional cooling top element); applicable for all topologies and OEM platforms

#### Patent Family 4:

(EP2026387B1)

Conductor cooling represents a new approach positioning of cells for cooling; pouch cell cooling, applicable for all topologies and OEM platforms, rather for smaller volumes

#### **Patent Family 5:**

(EP2497145B1 JP5810422B2 CN102771004B) Flat tube cooling represents a new approach for light, compact and efficient cooling by means of flat tubes with microstructures, applicable for all topologies and OEM platforms

## Lot 154 Technology Readiness Levels (TRL)

#### Patent Family 1:

(<u>EP2476151B1,</u> <u>US9112208B2, JP5542209B2,</u> <u>CN102576831B</u>) Module interface has TRL 6-7, must still be developed to series maturity

#### Patent Family 2:

(EP247461B1, CN10498601B, JP560335B2)

Balancing element TRL 7-8, still has to be developed for series production

#### Patent Family 3:

(EP2476160B1, US9083009B2, CN102576916B, JP5604519B2) Integrated bottom cooling has **TRL 9**; adoption for the respective series application; application examples can be found in series productions of several OEMs

### Patent Family 4:

(EP2026387B1)

Conductor cooling has also **TRL 9**; technology is expected to be used in series production

#### Patent Family 5:

(EP2497145B1 JP5810422B2 CN102771004B) Flat tube cooling has also **TRL 9.** Application examples can be found in series productions of several OEMs



BID EXP. PTO PRIORITY LOT REPRESENTATIVE **EVENT** BID ASK ASK EXP. PRIC NICKNAME DATA ROOM DATE NUMBER DATE\* USD/RMB\* USD/RMB\* SPR PATENT DATE DATE 竞价截止 日 拍品名称 数据服务室 拍品编号 劫 优先权日期 活动日 竞价 要价 要价截止日 价差 Data Processing \$3.800,000 03-ZHA-74-18 US US9047283 1/29/10 3/28/18 9/28/18 一种数据处理方法 ¥ 24.062,360.00

专利数量

市场一览

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**4 ASSETS** 

9 ASSETS

专利数量

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